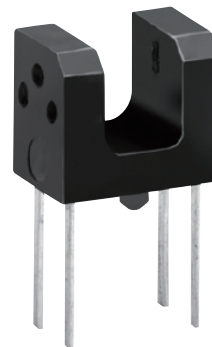


# Photomicrosensor (Transmissive)

# EE-SX1106

## Compact Slot/Terminal Type (Slot Width: 3 mm)

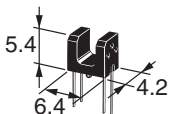
- Low profile (Height: 5.4 mm) type
- Terminal for PCB mounting
- Includes reverse insertion prevention boss



**⚠** Be sure to read *Safety Precautions* on Page 3.

## Ordering Information

### Photomicrosensor

Appearance	Sensing method	Connecting method	Sensing distance	Aperture size (H × W) (mm)	Output type	Model	Minimum packing unit (Unit: pcs)
	Transmissive (slot type)	Terminal for PCB mounting	3 mm (Slot width)	Both emitting side and detecting side 1.2 × 0.4	Phototransistor	<b>EE-SX1106</b>	1

**Note:** Order in multiples of minimum packing unit.

## Ratings, Characteristics and Exterior Specifications

### Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Rated value	Unit
<b>Emitter</b>			
Forward current	I <sub>F</sub>	50*1	mA
Pulse forward current	I <sub>FP</sub>	—	A
Reverse voltage	V <sub>R</sub>	5	V
<b>Detector</b>			
Collector-Emitter voltage	V <sub>CEO</sub>	30	V
Emitter-Collector voltage	V <sub>ECO</sub>	4.5	V
Collector current	I <sub>C</sub>	30	mA
Collector dissipation	P <sub>C</sub>	80*1	mW
Operating temperature	T <sub>opr</sub>	-25 to 85	°C
Storage temperature	T <sub>stg</sub>	-30 to 85	°C
Soldering temperature	T <sub>sol</sub>	260*2	°C

\*1. Refer to the temperature rating chart if the ambient temperature exceeds 25°C.

\*2. Complete soldering within 3 seconds.

### Exterior Specifications

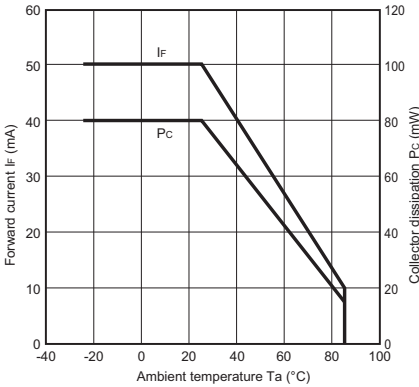
Connecting method	Weight (g)	Material	
		Case	Lens
Terminal for PCB mounting	0.2	PPS	Epoxy resin

### Electrical and Optical Characteristics (Ta = 25°C)

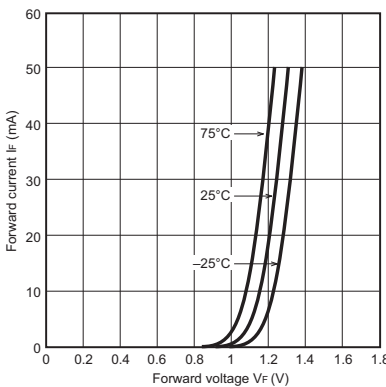
Item	Symbol	Value			Unit	Condition
		MIN.	TYP.	MAX.		
<b>Emitter</b>						
Forward voltage	V <sub>F</sub>	—	1.3	1.6	V	I <sub>F</sub> = 50 mA
Reverse current	I <sub>R</sub>	—	—	10	μA	V <sub>R</sub> = 5 V
Peak emission wavelength	λ <sub>P</sub>	—	950	—	nm	I <sub>F</sub> = 50 mA
<b>Detector</b>						
Light current	I <sub>L</sub>	0.2	—	—	mA	I <sub>F</sub> = 20 mA, V <sub>CE</sub> = 5 V
Dark current	I <sub>D</sub>	—	—	500	nA	V <sub>CE</sub> = 10 V, 0 lx
Leakage current	I <sub>LEAK</sub>	—	—	—	μA	—
Collector-Emitter saturated voltage	V <sub>CE (sat)</sub>	—	—	0.4	V	I <sub>F</sub> = 20 mA, I <sub>L</sub> = 0.1 mA
Peak spectral sensitivity wavelength	λ <sub>P</sub>	—	800	—	nm	V <sub>CE</sub> = 5 V
Rising time	t <sub>r</sub>	—	10	—	μs	V <sub>CC</sub> = 5 V, R <sub>L</sub> = 100 Ω, I <sub>F</sub> = 20 mA
Falling time	t <sub>f</sub>	—	10	—	μs	V <sub>CC</sub> = 5 V, R <sub>L</sub> = 100 Ω, I <sub>F</sub> = 20 mA

# Engineering Data (Reference Value)

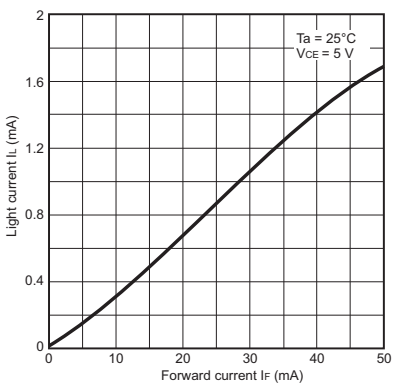
**Fig 1. Forward Current vs. Collector Dissipation Temperature Rating**



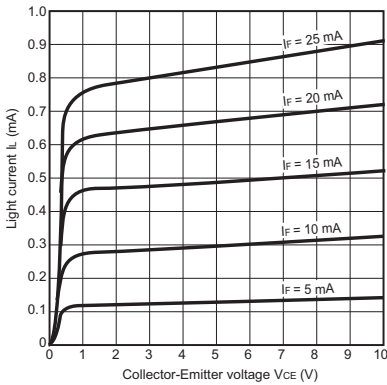
**Fig 2. Forward Current vs. Forward Voltage Characteristics (Typical)**



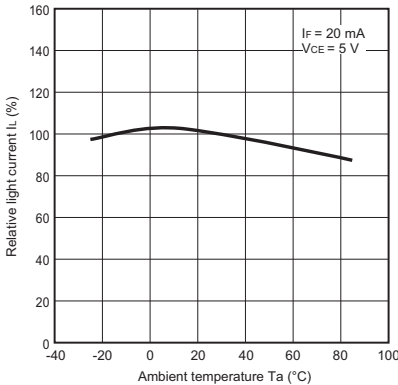
**Fig 3. Light Current vs. Forward Current Characteristics (Typical)**



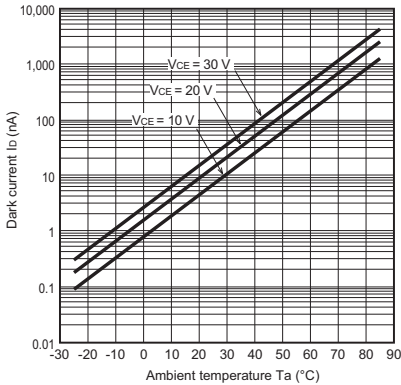
**Fig 4. Light Current vs. Collector-Emitter Voltage Characteristics (Typical)**



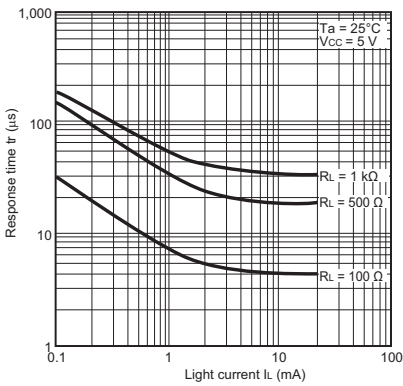
**Fig 5. Relative Light Current vs. Ambient Temperature Characteristics (Typical)**



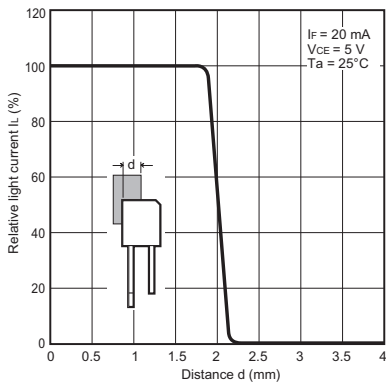
**Fig 6. Dark Current vs. Ambient Temperature Characteristics (Typical)**



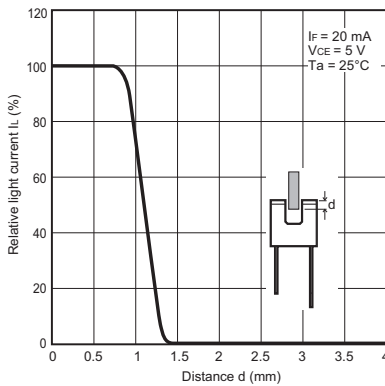
**Fig 7. Response Time vs. Light Current Characteristics (Typical)**



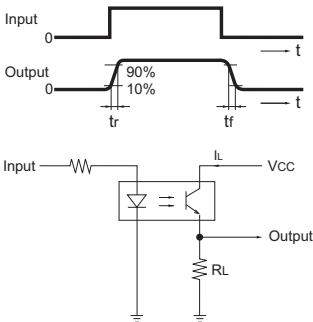
**Fig 8. Sensing Position Characteristics (Typical)**



**Fig 9. Sensing Position Characteristics (Typical)**



**Fig 10. Response Time Measurement Circuit**



# Safety Precautions

To ensure safe operation, be sure to read and follow the Instruction Manual provided with the Sensor.

**⚠ CAUTION**

This product is not designed or rated for ensuring safety of persons either directly or indirectly. Do not use it for such purposes.

**Precautions for Correct Use**

Do not use the product in atmospheres or environments that exceed product ratings.

**Precautions for Safe Use**

**Do not use the product with a voltage or current that exceeds the rated range.**  
Applying a voltage or current that is higher than the rated range may result in explosion or fire.

**Do not miswire such as the polarity of the power supply voltage.**  
Otherwise the product may be damaged or it may burn.

**This product does not resist water. Do not use the product in places where water or oil may be sprayed onto the product.**

## Dimensions and Internal Circuit

(Unit: mm)

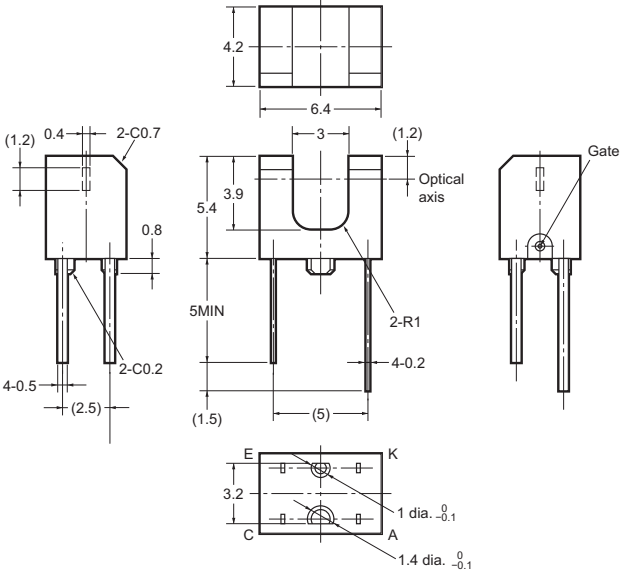
### Photomicrosensor

EE-SX1106

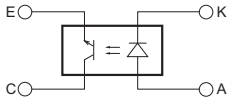


Aperture size (H x W)

Emitter	Detector
1.2 x 0.4	1.2 x 0.4



Internal circuit



Terminal No.	Name
A	Anode
K	Cathode
C	Collector
E	Emitter

**Note:** 1. Unless otherwise specified, the tolerances are ±0.2 mm.  
2. Dimensions in parentheses are for reference only.  
3. Dimensions of the slit are those of the primary mold.

Please check each region's Terms & Conditions by region website.

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**Device & Module Solutions Company**

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